

**TPSMD Series**



**Agency Approvals**

AGENCY	AGENCY FILE NUMBER
	E230531

**Maximum Ratings and Thermal Characteristics (T<sub>A</sub>=25°C unless otherwise noted)**

Parameter	Symbol	Value	Unit
Peak Pulse Power Dissipation at T <sub>A</sub> =25°C by 10/1000µs Waveform (Fig.2)(Note 1), (Note 2)	P <sub>PPM</sub>	3000	W
Power Dissipation on Infinite Heat Sink at T <sub>A</sub> =50°C	P <sub>M(AV)</sub>	6.5	W
Peak Forward Surge Current, 8.3ms Single Half Sine Wave (Note 3)	I <sub>FSM</sub>	300	A
Maximum Instantaneous Forward Voltage at 100A for Unidirectional Only	V <sub>F</sub>	3.5	V
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to 150	°C
Typical Thermal Resistance Junction to Lead	R <sub>θJL</sub>	15	°C/W
Typical Thermal Resistance Junction to Ambient	R <sub>θJA</sub>	75	°C/W

- Notes:**
1. Non-repetitive current pulse, per Fig. 4 and derated above T<sub>A</sub> = 25°C per Fig. 3.
  2. Mounted on copper pad area of 0.31x0.31" (8.0 x 8.0mm) to each terminal.
  3. Measured on 8.3ms single half sine wave or equivalent square wave for unidirectional device only, duty cycle=4 per minute maximum.

**Functional Diagram**



**Description**

The TPSMD series is designed specifically to protect sensitive electronic equipment from voltage transients induced by lightning and other transient voltage events.

**Features**

- Hi reliability application and automotive grade AEC Q101 qualified
- For surface mounted applications in order to optimize board space
- Low profile package
- Typical failure mode is short from over-specified voltage or current
- Whisker test is conducted based on JEDEC JESD201A per its table 4a and 4c
- IEC-61000-4-2 ESD 15kV(Air), 8kV (Contact)
- ESD protection of data lines in accordance with IEC 61000-4-2 (IEC801-2)
- EFT protection of data lines in accordance with IEC 61000-4-4 (IEC801-4)
- Built-in strain relief
- V<sub>BR</sub> @T<sub>J</sub> = V<sub>BR</sub> @25°C x (1 + α T x (T<sub>J</sub> - 25)) (α T: Temperature Coefficient)
- Glass passivated chip junction
- 3000W peak pulse power capability at 10/1000µs waveform, repetition rate (duty cycles):0.01%
- Fast response time: typically less than 1.0ps from 0V to BV min
- Excellent clamping capability
- Low incremental surge resistance
- Typical I<sub>R</sub> less than 2µA above 12V
- High temperature soldering guaranteed: 160°C/10 seconds at terminals
- Plastic package has underwriters laboratory flammability 94V-0
- Meet MSL level1, per J-STD-020, LF maximum peak of 260°C
- Matte tin lead-free plated
- Halogen free and RoHS compliant
- 2nd level interconnect is Pb-free per IPC/JEDEC J-STD-609A.01

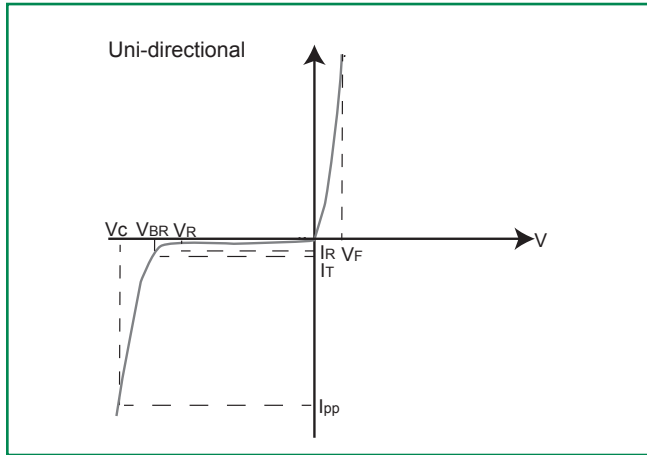
**Applications**

TVS devices are ideal for the protection of I/O Interfaces, V<sub>CC</sub> bus and other vulnerable circuits used in Telecom, Computer, Industrial and Consumer electronic applications.

### Electrical Characteristics

Part Number (Uni)	Marking	Reverse Stand off Voltage $V_R$ (Volts)	Breakdown Voltage $V_{BR}$ (Volts) @ $I_T$		Test Current $I_T$ (mA)	Maximum Clamping Voltage $V_C$ @ $I_{pp}$ (V)	Maximum Peak Pulse Current $I_{pp}$ (A)	Maximum Reverse Leakage $I_R$ @ $V_R$ ( $\mu$ A)	Agency Approval 
			MIN	MAX					
TPSMD10A	PDXA	10.0	11.10	12.30	1	17.0	176.5	5	X
TPSMD11A	PDZA	11.0	12.20	13.50	1	18.2	164.8	2	X
TPSMD12A	PEEA	12.0	13.30	14.70	1	19.9	150.8	2	X
TPSMD13A	PEGA	13.0	14.40	15.90	1	21.5	139.5	2	X
TPSMD14A	PEKA	14.0	15.60	17.20	1	23.2	129.3	2	X
TPSMD15A	PEMA	15.0	16.70	18.50	1	24.4	123.0	2	X
TPSMD16A	PEPA	16.0	17.80	19.70	1	26.0	115.4	2	X
TPSMD17A	PERA	17.0	18.90	20.90	1	27.6	108.7	2	X
TPSMD18A	PETA	18.0	20.00	22.10	1	29.2	102.7	2	X
TPSMD20A	PEVA	20.0	22.20	24.50	1	32.4	92.6	2	X
TPSMD22A	PEXA	22.0	24.40	26.90	1	35.5	84.5	2	X
TPSMD24A	PEZA	24.0	26.70	29.50	1	38.9	77.1	2	X
TPSMD26A	PFEA	26.0	28.90	31.90	1	42.1	71.3	2	X
TPSMD28A	PFGA	28.0	31.10	34.40	1	45.4	66.1	2	X
TPSMD30A	PFKA	30.0	33.30	36.80	1	48.4	62.0	2	X
TPSMD33A	PFMA	33.0	36.70	40.60	1	53.3	56.3	2	X
TPSMD36A	PFPA	36.0	40.00	44.20	1	58.1	51.6	2	X
TPSMD40A	PFRA	40.0	44.40	49.10	1	64.5	46.5	2	X
TPSMD43A	PFTA	43.0	47.80	52.80	1	69.4	43.2	2	X

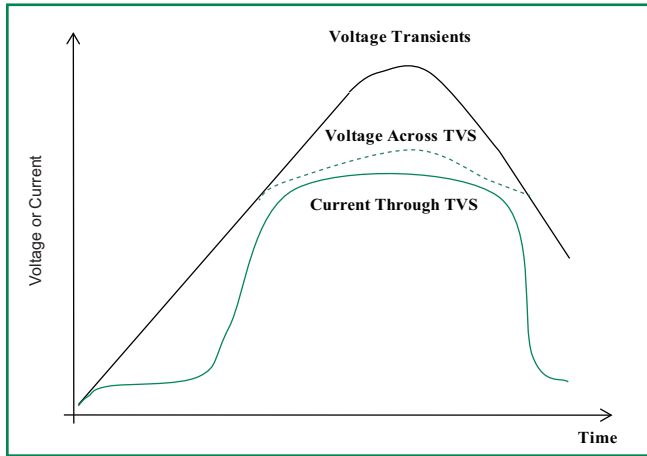
**I-V Curve Characteristics**



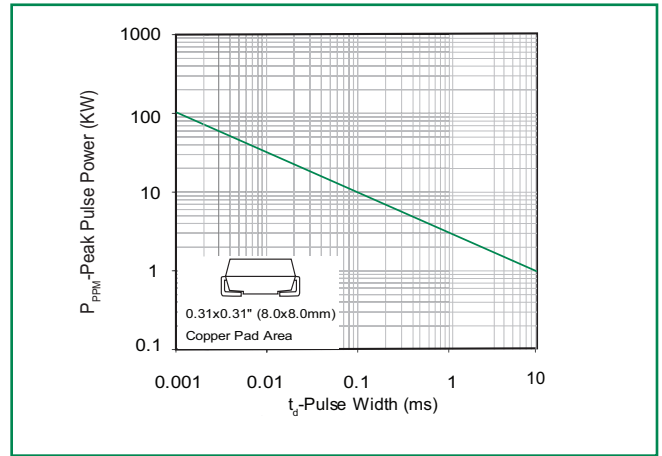
- P<sub>PPM</sub> Peak Pulse Power Dissipation** – Max power dissipation
- V<sub>R</sub> Stand-off Voltage** – Maximum voltage that can be applied to the TVS without operation
- V<sub>BR</sub> Breakdown Voltage** – Maximum voltage that flows thogh the TVS at a specified test current (I<sub>T</sub>)
- V<sub>C</sub> Clamping Voltage** – Peak voltage measured across the suppressor at a specified I<sub>ppm</sub> (peak impulse current)
- I<sub>R</sub> Reverse Leakage Current** – Current measured at V<sub>R</sub>
- V<sub>F</sub> Forward Voltage Drop for Uni-directional**

**Ratings and Characteristic Curves** (T<sub>A</sub>=25°C unless otherwise noted)

**Figure 1 - TVS Transients Clamping Waveform**



**Figure 2 - Peak Pulse Power Rating**



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**Ratings and Characteristic Curves** ( $T_A=25^\circ\text{C}$  unless otherwise noted) (Continued)

**Figure 3 - Peak Pulse Power or Current Derating Curve vs Initial Junction Temperature**



**Figure 4 - Pulse Waveform**



**Figure 5 - Typical Junction Capacitance**



**Figure 6 - Steady State Power Derating Curve**



**Figure 7 - Maximum Non-Repetitive Peak Forward Surge Current Uni-Directional only**



**Soldering Parameters**

Reflow Condition		Lead-free assembly
Pre Heat	- Temperature Min ( $T_{s(min)}$ )	150°C
	- Temperature Max ( $T_{s(max)}$ )	200°C
	- Time (min to max) ( $t_s$ )	60 – 120 secs
Average ramp up rate (Liquidus Temp ( $T_L$ ) to peak)		3°C/second max
$T_{s(max)}$ to $T_L$ - Ramp-up Rate		3°C/second max
Reflow	- Temperature ( $T_L$ ) (Liquidus)	217°C
	- Time (min to max) ( $t_s$ )	60 – 150 seconds
Peak Temperature ( $T_p$ )		260 <sup>+0/-5</sup> °C
Time within 5°C of actual peak Temperature ( $t_p$ )		30 seconds max
Ramp-down Rate		6°C/second max
Time 25°C to peak Temperature ( $T_p$ )		8 minutes max.
Do not exceed		280°C



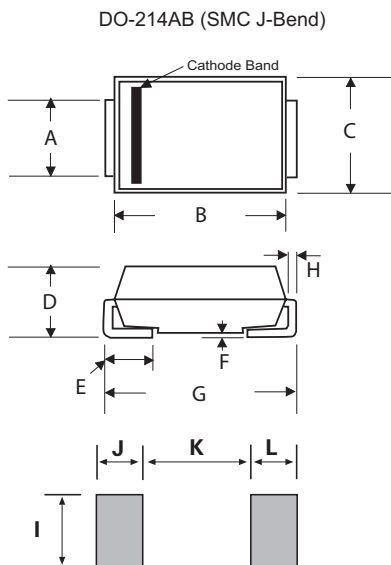
**Physical Specifications**

<b>Weight</b>	0.007 ounce, 0.21 grams
<b>Case</b>	JEDEC DO214AB. Molded plastic body over glass passivated junction
<b>Polarity</b>	Color band denotes positive end (cathode) except Bidirectional.
<b>Terminal</b>	Matte Tin-plated leads, Solderable per JESD22-B102

**Environmental Specifications**

<b>High Temp. Storage</b>	JESD22-A103
<b>HTRB</b>	JESD22-A108
<b>Temperature Cycling</b>	JESD22-A104
<b>MSL</b>	JEDEC-J-STD-020, Level 1
<b>H3TRB</b>	JESD22-A101
<b>RSH</b>	JESD22-B106

**Dimensions**



Dimensions	Inches		Millimeters	
	Min	Max	Min	Max
A	0.114	0.126	2.900	3.200
B	0.260	0.280	6.600	7.110
C	0.220	0.245	5.590	6.220
D	0.079	0.103	2.060	2.620
E	0.030	0.060	0.760	1.520
F	-	0.008	-	0.203
G	0.305	0.320	7.750	8.130
H	0.006	0.012	0.152	0.305
I	0.129	-	3.300	-
J	0.094	-	2.400	-
K	-	0.165	-	4.200
L	0.094	-	2.400	-

### Part Numbering System



### Part Marking System



### Packaging Options

Part number	Component Package	Quantity	Packaging Option	Packaging Specification
TPSMDxxxX	DO-214AB	3000	Tape & Reel - 16mm tape/13" reel	EIA STD RS-481
TPSMDxxxX-T7	DO-214AB	500	Tape & Reel - 16mm tape /7" reel	EIA STD RS-481

### Tape and Reel Specification





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- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

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- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



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